Overview

## HP ProBook 455R G6 Notebook PC



- 1. Internal Microphones (2)
- 2. Webcam
- 3. Webcam LED
- 4. Clickpad
- 5. Hard Drive LED

- Left
- 6. SD Card Reader
- 7. Thermal Vent
- 8. USB 2.0 Port
- 9. Security Lock Slot (Lock sold separately)
- 10. Power Button

### Overview



### Right

- 1. Power connector
- 2. USB Type-C<sup>™</sup> 3.1 Gen 1 port
- 3. Ethernet port (RJ-45)
- 4. HDMI port (Cable not included)

- 5. USB 3.1 Gen 1 port
- 6. USB 3.1 Gen 1 port
- 7. Headphone/Microphone Combo Jack
- 8. Optional HP Fingerprint Sensor

### Overview

## At a Glance

- Preinstall Windows 10 or FreeDOS 3.0
- Choice of 2nd Generation AMD Ryzen<sup>™</sup> processors
- Display include your choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD
- Integrated AMD Radeon<sup>TM</sup> Vega UMA Graphics
- Enhanced security features including TPM2.0, HP BIOSphere, Hardware enforced Firmware Protection, optional Fingerprint sensor<sup>3</sup>, and optional IR camera<sup>3</sup>
- Passed 19 MIL-STD 810 G testing, plus an additional 120,000 hours of reliability testing through HP's Total Test Process<sup>1</sup>
- Weight starting at 4.41 lbs (2 kgs)
- HP Long-Life Rechargeable batteries, with HP Fast Charge Technology recharges 50% in 30 minutes<sup>2</sup>
- Battery life Up to 13 hours and 45 minutes
- Supports wireless LAN
- Up to 512 GB Solid State Drives and 1 TB Hard Drive
- Up to 16 GB total system memory
- 720 p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistant and optional backlit Keyboard with numeric keypad<sup>3</sup>, and Clickpad with multi-touch gestures enabled, taps enabled as default
- MIL-STD-810G testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapte provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.
- 3. Sold separately or as an optional feature.

### NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

Preinstalled

## **PRODUCT NAMES**

HP ProBook 455R G6 Notebook PC

## **OPERATING SYSTEMS**

Windows 10 Pro 64<sup>1</sup> Windows 10 Pro 64 (National Academic only)<sup>2</sup> Windows 10 Home 64<sup>1</sup> Windows 10 Home Single Language 64<sup>1</sup> FreeDOS 3.0

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

## PROCESSORS

AMD Ryzen<sup>TM</sup> 5 3500U APU with Radeon<sup>TM</sup> Vega 8 Graphics (2.1 GHz base clock, up to 3.7 GHz max boost clock, 4 MB cache, 4 cores) <sup>3,4,5,6</sup>

AMD Ryzen<sup>TM</sup> 3 3200U APU with Radeon<sup>TM</sup> Vega 3 Graphics (2.6 GHz base clock, up to 3.5 GHz max boost clock, 4 MB cache, 4 cores)<sup>3,4,5,6</sup>

#### **Processors Family**

AMD Ryzen<sup>TM</sup> APU processor<sup>6</sup>

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on produconfigured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <a href="http://www.support.hp.com">http://www.support.hp.com</a>.

## CHIPSET

Integrated with processor

## GRAPHICS

Integrated Radeon<sup>™</sup> Vega Graphics<sup>7</sup>

Supports Support HD decode, DX12, HDMI 1.4b to 4K 30 Hz

7. HD content required to view HD images.

## DISPLAYS

#### Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB, two WLAN antennas (1366 x 768) 7,8 39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD camera, one WLAN antenna (1366 x 768) 7,8 39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD camera, two WLAN antennas (1366 x 768) 7,8 39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD + IR camera, two WLAN antennas (1366 x 768)<sup>7,8</sup> 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB, two WLAN antennas (1920 x 1080) 7,8 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD camera, one WLAN antenna (1920 x 1080)<sup>7,8</sup> 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD camera, two WLAN antennas (1920 x 1080)<sup>7,8</sup> 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m<sup>2</sup>, 67% sRGB for HD + IR camera, two WLAN antennas (1920 x 1080) 7,8

**Touch** Supports narrow bezel

HDMI HDMI1.4b, up to 4K 30Hz

7. HD content required to view HD images.8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

## STORAGE AND DRIVES

## **Technical Specifications**

### **Primary Storage**

1 TB 5400 rpm SATA<sup>9</sup> 500 GB 7200 rpm SATA<sup>9</sup>

#### Primary M.2 Storage

128 GB SATA TLC Solid State Drive<sup>9</sup> 256 GB PCIe<sup>®</sup> NVMe<sup>TM</sup> Value Solid State Drive<sup>9</sup> 512 GB PCIe<sup>®</sup> NVMe<sup>TM</sup> TLC Solid State Drive<sup>9</sup> 512 GB PCIe<sup>®</sup> NVMe<sup>TM</sup> Value Solid State Drive<sup>9</sup>

Note: PCIe SSD not available for Celeron

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

## **MEMORY**

Maximum Memory 16 GB DDR4-2400 SDRAM<sup>10</sup>

#### Memory

16 GB DDR4- 2400 SDRAM (2 X 8 GB)<sup>10</sup> 12 GB DDR4- 2400 SDRAM (1 x 4 GB and 1 x 8 GB)<sup>10</sup> 8 GB DDR4- 2400 SDRAM (1 x 8 GB) 8 GB DDR4- 2400 SDRAM (2 x 4 GB)<sup>10</sup> 4 GB DDR4- 2400 SDRAM (1 x 4 GB)

### **Memory Slots**

2 SODIMM Both slots are customer accessible / upgradeable DDR4 PC4 SODIMMS, system runs at 2400 Supports Dual Channel Memory

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

## **NETWORKING/COMMUNICATIONS**

### **Technical Specifications**

### WLAN

Realtek RTL8822BE 802.11ac (2x2) Wi-Fi<sup>®</sup> and Bluetooth<sup>®</sup> 4.2 Combo<sup>11</sup> Realtek RTL8821CE 802.11ac (1x1) Wi-Fi<sup>®</sup> and Bluetooth<sup>®</sup> 4.2 Combo<sup>11</sup>

### Ethernet

Realtek RTL8111HSH-CG 10/100/1000 GbE NIC<sup>12</sup>

11. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. 12. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

## AUDIO/MULTIMEDIA

### Audio

Integrated Microphone (Mono or Dual Array) 2 Integrated Stereo Speakers

#### **Camera** 720p HD Camera<sup>7</sup> 720p HD Camera+IR Camera<sup>7,13</sup>

**Sensors** Accelerometer Hall sensor

7. HD content required to view HD images.
 13. Sold separately or as an optional feature.

## **KEYBOARDS/POINTING DEICES/BUTTONS & FUNCTION KEYS**

### **Technical Specifications**

#### Keyboard

HP Premium Keyboard, spill resistant with numeric keypad and optional backlit<sup>14</sup> 14. Backlit keyboard is an optional feature.

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

F1 - Display Switching F2 - Blank F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute F6 - Volume Down F7 - Volume Up F8 - Mic Mute F9 - Blank or Backlit Toggle F10 - Blank F11 - Wireless F12 - Sleep **Hidden Functions** 

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock

## SOFTWARE AND SECURITY

#### BIOS

HP BIOSphere Gen4<sup>15</sup> HP DriveLock & Automatic DriveLock<sup>16</sup> **BIOS Update via Network** Secure Erase<sup>17</sup> Absolute Persistence Module<sup>18</sup> **Pre-boot Authentication HP** Wireless Wakeup

#### Software

HP Native Miracast Support<sup>19</sup> **HP LAN-Wireless Protection HP** Connection Optimizer HP 3D DriveGuard HP Support Assistant<sup>20</sup> **HP** Noise Cancellation Software HP Host Based MAC Address Manager Buy Office (Sold separately)

#### **Manageability Features**

HP Driver Packs<sup>21</sup> HP System Software Manager (SSM) HP BIOS Config Utility (BCU) **HP** Client Catalog

### **Technical Specifications**

HP Manageability Integration Kit Gen3<sup>22</sup>

#### **Client Security Software**

HP Client Security Suite Gen4<sup>23</sup> including: HP Security Manager<sup>24</sup> (including Credential Manager, HP Password Manager, HP Spare Key) HP Fingerprint Sensor<sup>25</sup> HP Power On Authentication Windows Defender<sup>26</sup>

#### Security Management

Secure Erase<sup>17</sup>

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)<sup>27</sup> SATA 0,1 port disablement (viaBIOS) Serial, USB enable/disable (viaBIOS) Power-on password (viaBIOS) Setup password (viaBIOS) Support for chassis padlocks and cable lock devices Integrated hood sensor HP Sure Click<sup>28</sup>

15. HP BIOSphere Gen4 requires Intel<sup>®</sup> or AMD 8th Gen processors. Features may vary depending on the platform and configurations.

16. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

17. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.

18. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside

the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

20. HP Support Assistant requires Windows and Internet access.

21. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

22. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html

23. HP Client Security Suite Gen 4 requires Windows and Intel<sup>®</sup> or AMD 7th or 8th generation processors.

24. HP Password Manager requires Internet Explorer or Chrome or Firefox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

25. HP Fingerprint Sensor sold separately or as an optional feature.

26. Windows Defender Opt In, Windows 10, and internet connection required for updates.

27. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

28. HP Sure Click is available on most HP PCs and supports Microsoft<sup>®</sup> Internet Explorer and Chromium<sup>TM</sup>. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

## POWER

### **Technical Specifications**

#### Power Supply

HP Smart 65 W External AC power adapter<sup>29</sup> HP Smart 65 W EM External AC power adapter<sup>29</sup> HP Smart 65 W USB Type-C<sup>TM</sup> adapter<sup>29</sup> HP Smart 45 W External AC power adapter<sup>29</sup> HP Smart 45 W USB Type-C<sup>TM</sup> adapter<sup>29</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Li-ion polymer<sup>30</sup>

**Battery Life** Up to 13 hours and 45 minutes<sup>31</sup>

#### **Power Cord**

3-wire plug - 1.8 m<sup>29</sup> 3-wire plug - 1 m<sup>29</sup> 2-wire plug - 1 m<sup>29</sup> Duckhead power cord - 1.0m<sup>29</sup> Duckhead power cord - 1.8m<sup>29</sup>

#### **Battery Weight**

0.49 lb 0.22 kg

29. Availability may vary by country.
30. Battery is internal and not replaceable by customer. Serviceable by warranty.
31. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage.
See http://www.bapco.com for additional details.

## **WEIGHTS & DIMENSIONS**

**Weight** Starting at 4.41 lbs<sup>32</sup> Starting at 2 kgs<sup>32</sup>

**Dimensions (w x d x h)** 14.37 x 10.11 x 0.75 in 36.49 x 25.69 x 1.9 cm

32. Weight will vary by configuration.

## **PORTS/SLOTS**

### **Technical Specifications**

#### Ports

1 USB 3.1 Type-C<sup>TM</sup> Gen 1 (Power delivery, DisplayPort<sup>TM</sup>) 2 USB 3.1 Gen 1 1 USB 2.0 (charging) 1 HDMI 1.4b<sup>33</sup> 1 RJ-45 1 AC power 1 Headphone/Microphone Combo Jack

#### **Expansion Slots**

1 SD Supports SD, SDHC, SDXC

33. HDMI cable sold separately.

### SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.<sup>34</sup>

34. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

## **ENVIRONMENTAL & INDUSTRY**

Eco-Label Certifications &	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:		
declarations	<ul> <li>IT ECO declaration</li> <li>US ENERGY STAR®</li> <li>EPEAT® Silver registered i registration status in your c</li> <li>TCO Certified 8.0</li> </ul>	n the United States. See http://www ountry.	epeat.net for
System	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook mode		
Configuration	is based on a Typically Configured Notebook.		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC. 60Hz	230VAC. 50Hz	100VAC. 50Hz

## Technical Specifications

Normal Operation (Short idle)	7.452 W	7.620	W	7.512 W
Normal Operation (Long idle)	4.884 W	5.052	W	4.932 W
Sleep	0.528 W	0.576	W	0.540 W
Off	0.312 W	0.336		0.312 W
	Energy efficiency data listed is for an El computers marked with the ENERGY ST Agency (EPA) ENERGY STAR® specificati compliant configurations, then energy drive, a high efficiency power supply, a	AR <sup>®</sup> Logo are compliar ions for computers. If a efficiency data listed is	nt with the applicable model family does r for a typically config	e U.S. Environmental Protect not offer ENERGY STAR® gured PC featuring a hard dis
Heat	115VAC, 60Hz	230VAC, !	50Hz	100VAC, 50Hz
Dissipation*				
Normal Operation (Short idle)	25 BTU/hr	26 BTU,	/hr	26 BTU/hr
Normal Operation (Long idle)	17 BTU/hr	17 BTU,	/hr	17 BTU/hr
Sleep	2 BTU/hr	2 BTU/	hr	2 BTU/hr
Dff	1 BTU/hr	1 BTU/		1 BTU/hr
	Heat dissipation is calculated based on	the measured watts, as	suming the service	evel is attained for one hour
Declared Noise Emissions	Sound Power (L <sub>WAd</sub> , bels)			und Pressure <sub>Am</sub> , decibels)
(in accordance with ISO 7779 and ISO 9296)				
Typically Configured - Idle	2.7			14
Fixed Disk - Random writes	3.1			14
Longevity and Upgrading	<ul> <li>This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:</li> <li>3 USB ports</li> <li>1 PC card slot (type I/II)</li> <li>1 ExpressCard/54 slot</li> <li>1 IEEE 1394 Port</li> <li>2 SODIMM memory slots</li> <li>Optional expansion base docking station</li> <li>1 multi-bay II storage port</li> <li>Interchangeable HDD</li> </ul> Spare parts are available throughout the warranty period and or for up to "5"? years after the end of production.			
Batteries	This battery(s) in this product comply Batteries used in the product do not of Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight	contain:	06/66/EC	
	Battery size: CR2032 (coin cell)			

## **Technical Specifications**

Additional Information Packaging	<ul> <li>Battery type: lithium/manganese dioxide</li> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see http://www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product contains 3% post-consumer recycled plastic (by wt.)</li> <li>This product is 94.5% recycle-able when properly disposed of at end of life.</li> </ul>		
Materials	Internal:	PLASTIC/Polyethylene Expanded - EPE	68 g
	internal.	PLASTIC/Polyethylene low density - LDPE	
	PLASTIC/Polyethylene low density - LDPE     10 g       This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):     Asbestos       Certain Azo Colorants     Certain Brominated Flame Retardants - may not be used as flame retardants in plastics       Cadmium     Chlorinated Hydrocarbons       Chlorinated Paraffins     Formaldehyde       Halogenated Diphenyl Methanes     Lead carbonates and sulfates       Lead and Lead compounds     Mercuric Oxide Batteries       Nickel - finishes must not be used on the external surface designed to be frequently handled or carried by the user.       Ozone Depleting Substances       Polybrominated Biphenyl Ethers (PBBEs)       Polybrominated Biphenyl Oxides (PBBOs)       Polychlorinated Biphenyl Oxides (PBBOs)       Polychlorinated Biphenyl (PCB)       Polychlorinated Flerphyls (PCT)       Polychlorinated Biphenyl (PCCT)       Polychlorinated Flerphyls (PCT)       Polychlorinated Flerphyls (PCT) <td< th=""></td<>		
Packaging Usage	<ul> <li>Eliminate materials.</li> <li>Eliminate</li> <li>Design pa</li> <li>Maximize</li> <li>Use readi</li> <li>Reduce si</li> </ul>	the use of heavy metals such as lead, chromium, me the use of ozone-depleting substances (ODS) in pac- ackaging materials for ease of disassembly. the use of post-consumer recycled content materials ly recyclable packaging materials such as paper and ize and weight of packages to improve transportation ackaging materials are marked according to ISC	ercury and cadmium in packaging kaging materials. s in packaging materials. corrugated materials. fuel efficiency.
End-of-life	HP Inc. offers en	d-of-life HP product return and recycling programs in ma	any geographic areas. To recycle you

### **Technical Specifications**

Management and Recycling	product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP Inc.	For more information about HP's commitment to the environment:
Corporate	
Environmental	Global Citizenship Report
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/
	PC_GBU_Product_Design_ISO_14K_Certificate.pdf
	and
	http://www.hp.com/hpinfo/qlobalcitizenship/environment/pdf/cert.pdf

## SYSTEM UNIT

### **Stand-Alone Power Requirements**

Stand-Atome i ower kegan ements	
(AC Power)	
Nominal Operating Voltage	19V
Average Operating Power	Windows 10
Integrated graphics	Data is not available (APU 15W)
Max Operating Power	UMA < 45W
Temperature	
Operating	32° to 95° F (0° to 35° C)
Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	
Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	
Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	0.75 grms
Non-operating	1.50 grms
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard Certifications	
UL	Yes
CSA	Yes
FCC Compliance	Yes
ENERGY STAR <sup>®</sup>	Selected models <sup>35</sup>
EPEAT	Registered Silver in United States <sup>36</sup>
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
	Yes
Japan VCCI Compliance	Yes
KC	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	Yes

### Technical Specifications

CIT	Yes
GOST	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes
UKRSERTCOMPUTER	Yes

35. Configurations of the HP ProBook 455R G6 that are ENERGY STAR<sup>®</sup> qualified are identified as HP ProBook 455R G6 ENERGY STAR on HP websites and on http://www.energystar.gov.

36. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options.

### DISPLAYS

**NOTE**: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may varge either higher or lower.

Panel LCD 15.6 inch	Outline Dimensions (W x H x D)	350.96 x 216.75 (max.)
diagonal FHD (1920x1080)	Active Area	344.16 x 193.59 (typ.)
Anti-Glare WLED UWVA 45% cg 220nits eDP slim NB	Weight	<370g max.
· · · · · · · · · · · · · · · · · · ·	Diagonal Size	15.6"
	Thickness	3.2mm max.
	Interface	eDP 1.2
	Surface Treatment	Anti-glare
	Touch Enabled	No
	Contrast Ratio	600:1 (typ) - AG
	Refresh Rate	60Hz
	Brightness	220 nits typical (Panel Only)
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	45%
	Color Depth	6 bits + Hi FRC
	Viewing Angle	UWVA 85/85/85/85

### **Technical Specifications**

Panel LCD 15.6 inch diagonal
HD (1366x768) Anti-Glare
WLED SVA 45% cg 220nits eDP
1.2 w/o PSR slim NB

Outline Dimensions (W x H x D)	350.96 x 216.75 (max.)
Active Area	344.16 x 193.59 (typ.)
Weight	<370g max.
Diagonal Size	15.6"
Thickness	3.2mm max.
Interface	eDP 1.2
Surface Treatment	Anti-glare
Touch Enabled	No
Contrast Ratio	300:1 (typ)
Refresh Rate	60Hz
Brightness	220 nits typical (Panel Only)
Pixel Resolution	1366 x 768 (HD)
Format	RGB
Backlight	LED
Color Gamut Coverage	45%
Color Depth	6 bits + Hi FRC
Viewing Angle	SVA 40/40/15/30

## **STORAGE AND DRIVES**

### HARD DRIVES

500 GB 7200 rpm SATA Hard Drive

Drive Weight	0.20 lbs (92 g) ~ 0.21 lbs (95 g)
Rotation speed	7200 rpm
Cache Buffer	Up to 32 MB
Height	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
Transfer Rate	600 MB/s
Seek Time	Single Track: 2 ~ 1.5 ms Average: 11 ~ 13 ms Maximum: 18 ~ 22 ms
Logical Blocks	976,773,168
Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
Security Features	ATA Security
Features	S.M.A.R.T., NCQ, Ultra DMA

### **Technical Specifications**

	-	
1 TB 5400 rpm SATA Hard	Drive Weight	0.21 lbs (94 g)
Drive	Rotation speed	5400 rpm
	Cache Buffer	Up to 32 MB
	Height	0.28 in (7.2 mm)
	Width	2.75 in (69.85 mm)
	Interface	ATA-8, SATA 3.0
	Transfer Rate	600 MB/s
	Seek Time	Single Track 2 ms Average 12 ~ 13 ms Maximum 18 ~ 22 ms
	Logical Blocks	1,953,525,168
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Security Features	ATA Security
	Features	S.M.A.R.T., NCQ, Ultra DMA
SSD 128 GB 2280 M2	Form Factor	M.2 2280
SATA-3 TLC	Capacity	128 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	ATA-8, SATA 3.0
	Maximum Sequential Read	Up To 520 MB/s
	Maximum Sequential Write	Up To 450 MB/s
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	DIPM; TRIM; DEVSLP
256 GB 2280 PCIe NVMe	Form Factor	M.2 2280
Value Solid State Drive	Capacity	256 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen 3
	Maximum Sequential Read	Up To 1700 MB/s
	Maximum Sequential Write	Up To 1300 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2

## **Technical Specifications**

512 GB 2280 M2 PCIe NVMe TLC Solid State Drive	Form Factor	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen 3X4
	Maximum Sequential Read	Up To 2600 MB/s
	Maximum Sequential Write	Up To 1400 MB/s
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2
SSD 512 GB 2280 PCIe NVMe	Form Factor	M.2 2280
Value	Capacity	512 GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 plb (10 g)
	Interface	PCIe NVMe Gen 3X4
	Maximum Sequential Read	Up To 1700 MB/s
	Maximum Sequential Write	Up To 1500 MB/s
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2

## **NETWORKING/COMMUNICATIONS**

### WLAN

Realtek 802.11a/b/g/n/ac (2x2) WiFi® and Bluetooth® 4.2 Combo <sup>1</sup>	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac
	Interoperability	Wi-Fi <sup>®</sup> certified
	Frequency Band	802.11b/g/n
		• 2.402 - 2.482 GHz 802.11a/n/ac
		<ul> <li>4.9 - 4.95 GHz (Japan)</li> <li>5.15 - 5.25 GHz</li> <li>5.25 - 5.35 GHz</li> <li>5.47 - 5.725 GHz</li> </ul>

**Technical Specifications** 

	• 5.825 - 5.850 GHz
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)</li> </ul>
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>3</sup>	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> </ul>
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>2</sup>	<ul> <li>802.11b: +14dBm minimum</li> <li>802.11g: +12dBm minimum</li> <li>802.11a: +12dBm minimum</li> <li>802.11n HT20(2.4GHz): +12dBm minimum</li> <li>802.11n HT40(2.4GHz): +12dBm minimum</li> <li>802.11n HT20(5GHz): +10dBm minimum</li> <li>802.11n HT40(5GHz): +10dBm minimum</li> <li>802.11ac VHT80(5GHz): +10dBm minimum</li> </ul>
Power Consumption	Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10 mW Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230: 2.3 x 22.0 x 30.0 mm
Weight	Type 2230: 2.8g

## Technical Specifications

Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber - Rac	lio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

<b>Bluetooth Specification</b>	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Signaling Data Rate <sup>4</sup>	Legacy: 3 Mbps signaling data rate <sup>1</sup> 2.17 Mbps
	BLE: 1 Mbps signaling data rate <sup>1</sup> 0.2 Mbps 1. Actual throughput may vary.
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Electrical Interface	USB 2.0 compliant
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy LE Privacy 1.2 -Extended Scanner Filter Policies LE Data Packet Length Extension

## **Technical Specifications**

FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

4. Actual throughput may vary

Realtek 802.11a/b/g/n/ac (1x1) WiFi® and Bluetooth® 4.2 Combo <sup>1</sup>	Wireless LAN Standards Interoperability Frequency Band	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi® certified 802.11b/g/n
		• 2.402 - 2.482 GHz 802.11a/n
		<ul> <li>4.9 - 4.95 GHz (Japan)</li> <li>5.15 - 5.25 GHz</li> <li>5.25 - 5.35 GHz</li> <li>5.47 - 5.725 GHz</li> <li>5.825 - 5.850 GHz</li> </ul>
	Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)</li> </ul>
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security <sup>3</sup>	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> </ul>
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming Output Power <sup>2</sup>	IEEE 802.11 compliant roaming between access points • 802.11b: +14dBm minimum • 802.11g: +12dBm minimum • 802.11a: +12dBm minimum • 802.11n HT20(2.4GHz): +12dBm minimum

Technical Specifications			
	<ul><li>802.11</li><li>802.11</li></ul>	n HT40(2.4GHz): +12dBm minimum n HT20(5GHz): +10dBm minimum n HT40(5GHz): +10dBm minimum ac VHT80(5GHz): +10dBm minimum	
Power Consump	Receive mode Idle mode (PSF	1.6W P) 180 mW (WLAN Associated) nW (WLAN unassociated) ndby 10 mW	
Power Managen		ACPI and PCI Express compliant power management 802.11 compliant power saving mode	
Receiver Sensit	802.11b, 11Mb 802.11a/g, 6M 802.11a/g, 54ľ 802.11n, MCS0 802.11n, MCS1 802.11ac, MCS	802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum	
Antenna type	One embedded	High efficiency antenna. One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications	
Form Factor	PCI-Express M.	PCI-Express M.2 MiniCard	
Dimensions	Туре 2230: 2.3	3 x 22.0 x 30.0 mm	
Weight	Туре 2230: 2.8	Туре 2230: 2.8g	
Operating Volta	ige 3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber - Ra	adio OFF; LED White - Radio ON	

### **Technical Specifications**

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

II Blueloolii 4.0/4.1/4.2 Wilel	
Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Signaling Data Rate <sup>1</sup>	Legacy: 3 Mbps signaling data rate <sup>1</sup> 2.17 Mbps
	BLE: 1 Mbps signaling data rate <sup>1</sup> 0.2 Mbps 1. Actual throughput may vary.
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
<b>Electrical Interface</b>	USB 2.0 compliant
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Supported	LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy LE Privacy 1.2 -Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
driver release for undates on s	supported security features

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

4. Actual throughput may vary

## **Technical Specifications**

## POWER

HP 45 W	Dimensions (H x W x D)	3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)	
Smart AC adapter	Weight	0.386 lb (175g) max	
	Input	90 to 265 VAC	
		Input Efficiency	87.74% at 115Vac and 88.4% at 230Vac
		Input frequency range	47 to 63 Hz
		Input AC current	1.4 A at 90 VAC
	Output	Output power	45W
		DC output	19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<8.0A
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable core	
Environmental Design	Environmental Design	Operating temperature	32° F to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° F to 1850F (-20o to 85° C)
		Altitude	0 to 16,400 ft (0 to 5,000 m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety	*CE Mark - full compliance with LVD and EMC directives	
	Certifications	* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.	
		* MTBF - over 200,000 hours	s at 25°C ambient condition.

### Technical Specifications

HP 65 W	Dimensions	90 x 51 x 28.5mm		
Smart AC adapter	Weight	unit: 220g +/- 10g		
	Input	Input Efficiency	88% min at 115 VAC and 89% min at 230 VAC	
		Input frequency range	47 to 63 Hz	
		Input AC current	1.7 A at 90 VAC	
	Output	Output power	65W	
		DC output	19.5V	
		Hold-up time	5 msec at 115 VAC input	
		Output current limit	<11.0A	
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords		
	Environmental Design	Operating temperature	32° F to 95° F (0° to 35° C)	
		Non-operating (storage) temperature	-4° F to 185° F (-20° to 85° C)	
		Altitude	0 to 16,400 ft (0 to 5000m)	
		Humidity	20% to 95%	
		Storage Humidity	10% to 95%	
	EMI and Safety Certifications	*CE Mark - full complianc	e with LVD and EMC directives	
		-	ards - IEC60950, EN60950, UL60950, Class1, · C-UL-US, NORDICS, DENAN, EN55022 Class B, FC CCC, NOM-1 NYCE.	
		* MTBF - over 200,000 hc	ours at 25°C ambient condition.	
HP 65 W	Dimensions	102 x 55 x 30mm		
EM Smart AC adapter	Weight	270g +/- 10g		
	Input	Input Efficiency	87% min at 115V/230V	
		Input frequency range	47 to 63 Hz	
		Input AC current	1.7 A at 90 VAC and maximum load	
		DC output	65 W(19.5V/3.33A)	
		Hold-up time	5 msec at 115 VAC input	
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown	
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords		
	<b>Environmental Design</b>	Operating	0° to 35° C	

temperature

temperature Altitude

**Storage Humidity** 

Humidity

Non-operating (storage) -20° to 85° C

0 to 5,000 m

0% to 95%

0% to 95%

#### **Technical Specifications EMI and Safetv** \*CE Mark - full compliance with LVD and EMC directives Certifications \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. \* MTBE - over 200.000 hours at 25°C ambient condition. Dimensions 74 x 74 x 28.5mm AC Adapter 65 W nPFC USB type C Weight unit: 245g +/- 10g Input **Input Efficiency** 81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A 47 to 63 Hz Input frequency range **Input AC current** 1.7 A at 90 VAC and maximum load **Output power** 65W **DC** output 5V/9V/10V/12V/15V/20V Hold-up time 5ms at 115 Vac input **Output current limit** <8.0A Connector Type C **Environmental Design** Operating 32°F to 95°F (0° to 35°C) temperature Non-operating (storage) -4°F to 185°F (-20°to 85°C) temperature Altitude 0 to 16,400 ft (0 to 5000m) Humidity 0% to 95% **Storage Humidity** 0% to 95% **EMI and Safety** \*CE Mark - full compliance with LVD and EMC directives Certifications \* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FC( Class B, CISPR22 Class B, CCC, NOM-1 NYCE. \* MTBF - over 200,000 hours at 25°C ambient condition.

Technical Specificat	tions		
AC Adapter 45 W nPFC USB type C	Dimensions	62.0 x 62.0 x 28.5mm	
	Weight	unit: 220g +/- 10g	
	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec:5V: 81.5%9V: 86.7%10V: 87.5%12V: 87.8%15V: 87.8%20V: 87.8%
		Input frequency range	47 to 63 Hz
		Input AC current	Max. 1.4 A at 90 Vac
		Output power	5V/15W 9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W
		DC output	5V/9V/10V/12V/15V/20V
		Hold-up time	5ms at 115 Vac input
		Output current limit	<5.0A
	Connector	Туре С	
	Environmental Design	Operating temperature	32° F to 95° F (0° to 35° C)
		Non-operating (storage) temperature	-4° F to 185° F (-20° to 85° C)
		Altitude	-4° F to 185° F (-20° to 85° C)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety	*CE Mark - full compliance with LVD and EMC directives	
	Certifications	* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.	
		* MTBF - over 200,000 ho	urs at 25°C ambient condition.

3 Cell WHr 45 Long Life -	Dimensions (H x W x L)	6.0. x 184.7 x 88.9 mm
Polymer HP Fast Charge Technology <sup>1</sup>	Weight	0.22 kg (0.48lb)
rechnology	Cells/Type	3cell Lithium-Ion
	Energy	
	Voltage	11.55 V
	Amp-hour capacity	3.900Ah
	Watt-hour capacity	45Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Optional Travel Battery Available	No
(		

## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Messenger Case (up to 17.3")	H1D25AA
Docking	HP USB-C Mini Dock	1PM64AA#xxx
Docking	HP USB-C Universal Dock	1MK33AA#xxx
	HP USB-C Dock G4	3FF69AA#xxx
	HP TB Dock 120W w/Audio	3YE87AA#xxx
	HP Thunderbolt Dock 120W G2	2UK37AA#xxx
	HP TB Dock G2 w/ Combo Cable	3TR87AA#xxx
	HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	3AQ21AA
	HP USB Travel Dock	TOK30AA#xxx
	DIB HP 400G6 HDD Bracket Kit	5LV47AV
Input/Output	HDMI to VGA Adapter	H4F02AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP USB Collaboration Keyboard	Z9N38AA#xxx
UCC	HP UC Speaker Phone	4VW02AA
UCC	HP Stereo 3.5 mm Headset	Т1А66АА
	HP Stereo USB Headset	T1A67AA
Power	HP Power Bank	N9F71AA#xxx
	HP 45W LC USB-C Power Adapter	1MZ01AA#ABA
	HP 45W Smart AC Adapter 4.5mm	H6Y88AA#xxx
	HP 65W Slim AC Adapter	H6Y82AA#xxx
	HP 65W USB-C Power Adapter	3PN48AA
	HP 45W USB-C Power Adapter	1HE07AA#xxx
	HP 65W USB-C Power Adapter	1HE08AA#xxx
	HP USB-C Power Bank	2NA10AA#xxx
Storage	HP External USB Optical Drive	F2B56AA
	HP 500GB 7200rpm HDD	F3B97AA
	HP 512GB TLC PCI-e 3x4 NVMe SSD (2280)	1FU88AA

## Options and Accessories (sold separately and availability may vary by country)

Memory	4GB 2666MHz DDR4	4VN05AA
	8GB 2666MHz DDR4	4VN06AA
	16GB 2666 MHz DDR4	4VN07AA
Convitor	UD Ferential Kound Cable Lack 12 Dama	TOV1444
Security	HP Essential Keyed Cable lock 12.3mm	TOY14AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP UltraSlim Keyed Cable Lock	T1A62AA
Displays	HP ProDisplay P240va 23.8 inch Monitor	N3H14AA
	HP ProDisplay P232 23 inch Monitor	K7X31AA
	HP EliteDisplay E223 21.5 inch Monitor	1FH45AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA
	HP EliteDisplay S14 14-inch Portable Display	3HX46AA

### Summary of Changes

Date of change:	Version History:		Description of change:
May 7, 2019	V1 to V2	Added	Environmental section, Updated at a glance section

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